

KEPITAL[®] SF-20

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POM, SUS fiber-filled, conductive - A SUS fiber-filled conductive grade for - Suitable for applications requiring elec				
Product information				
Part Marking Code		> POM-MEF20 <		ISO 11469
Rheological properties				
Moulding shrinkage, parallel		1.8	%	ISO 294-4, 2577
Typical mechanical properties				
Yield stress, 50mm/min			MPa	ISO 527-1/-2
Yield strain, 50mm/min			%	ISO 527-1/-2
Nominal strain at break Flexural Modulus		15 2750		ISO 527-1/-2 ISO 178
Flexural Strength			MPa	ISO 178
Charpy notched impact strength, 23°C	C		kJ/m ²	ISO 179/1eA
Thermal properties				
Melting temperature, 10°C/min		165	°C	ISO 11357-1/-3
Temp. of deflection under load, 1.8 MPa		93	°C	ISO 75-1/-2
Electrical properties				
Surface resistivity		10000	Ohm	IEC 62631-3-2
Other properties				
Density		1490	kg/m ³	ISO 1183
Other Approvals				
Other Approvals	OEM	Speci	fication	Additional Information
	GM	GMP.	POM.048	Natural

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